PZT2222AT1

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector-Emitter Breakdown Voltage ($I_C = 10 \text{ mAdc}, I_B = 0$)	V _{(BR)CEO}	40	-	Vdc
Collector-Base Breakdown Voltage ($I_C = 10 \ \mu Adc$, $I_E = 0$)	V _{(BR)CBO}	75	-	Vdc
Emitter-Base Breakdown Voltage ($I_E = 10 \ \mu Adc$, $I_C = 0$)	V _{(BR)EBO}	6.0	-	Vdc
Base-Emitter Cutoff Current (V_{CE} = 60 Vdc, V_{BE} = - 3.0 Vdc)	I _{BEX}	-	20	nAdc
Collector-Emitter Cutoff Current (V_{CE} = 60 Vdc, V_{BE} = - 3.0 Vdc)	I _{CEX}	-	10	nAdc
Emitter-Base Cutoff Current ($V_{EB} = 3.0 \text{ Vdc}, I_C = 0$)	I _{EBO}	_	100	nAdc
Collector-Base Cutoff Current ($V_{CB} = 60 \text{ Vdc}, I_E = 0$) ($V_{CB} = 60 \text{ Vdc}, I_E = 0, T_A = 125^{\circ}C$)	080		10 10	nAdc µAdc
ON CHARACTERISTICS				
DC Current Gain ($I_C = 0.1 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}$) ($I_C = 1.0 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}$) ($I_C = 10 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}$) ($I_C = 10 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}, T_A = -55^{\circ}\text{C}$) ($I_C = 150 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}$) ($I_C = 150 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}$) ($I_C = 500 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}$)	h _{FE}	35 50 70 35 100 50 40	- - - 300 -	_
Collector-Emitter Saturation Voltages ($I_C = 150 \text{ mAdc}, I_B = 15 \text{ mAdc}$) ($I_C = 500 \text{ mAdc}, I_B = 50 \text{ mAdc}$)	V _{CE(sat)}		0.3 1.0	Vdc
Base-Emitter Saturation Voltages ($I_C = 150 \text{ mAdc}, I_B = 15 \text{ mAdc}$) ($I_C = 500 \text{ mAdc}, I_B = 50 \text{ mAdc}$)	V _{BE(sat)}	0.6 -	1.2 2.0	Vdc
Input Impedance ($V_{CE} = 10 \text{ Vdc}$, $I_C = 1.0 \text{ mAdc}$, $f = 1.0 \text{ kHz}$) ($V_{CE} = 10 \text{ Vdc}$, $I_C = 10 \text{ mAdc}$, $f = 1.0 \text{ kHz}$)	h _{ie}	2.0 0.25	8.0 1.25	kΩ
Voltage Feedback Ratio ($V_{CE} = 10$ Vdc, $I_C = 1.0$ mAdc, $f = 1.0$ kHz) ($V_{CE} = 10$ Vdc, $I_C = 10$ mAdc, $f = 1.0$ kHz)	h _{re}		8.0x10 ⁻⁴ 4.0x10 ⁻⁴	_
$ Small-Signal Current Gain \\ (V_{CE} = 10 Vdc, I_C = 1.0 mAdc, f = 1.0 kHz) \\ (V_{CE} = 10 Vdc, I_C = 10 mAdc, f = 1.0 kHz) $	h _{fe}	50 75	300 375	_
Output Admittance ($V_{CE} = 10$ Vdc, $I_C = 1.0$ mAdc, $f = 1.0$ kHz) ($V_{CE} = 10$ Vdc, $I_C = 10$ mAdc, $f = 1.0$ kHz)	h _{oe}	5.0 25	35 200	μmhos
Noise Figure (V _{CE} = 10 Vdc, I _C = 100 μ Adc, f = 1.0 kHz)	F	-	4.0	dB
DYNAMIC CHARACTERISTICS				
Current-Gain – Bandwidth Product (I _C = 20 mAdc, V _{CE} = 20 Vdc, f = 100 MHz)	f _T	300	-	MHz
Output Capacitance (V_{CB} = 10 Vdc, I_E = 0, f = 1.0 MHz)	C _c	_	8.0	pF
Input Capacitance (V_{EB} = 0.5 Vdc, I_{C} = 0, f = 1.0 MHz)	C _e	-	25	pF
SWITCHING TIMES $(T_A = 25^{\circ}C)$				
Delay Time $(V_{CC} = 30 \text{ Vdc}, I_C = 150 \text{ mAdc},$	t _d	-	10	ns
Rise Time I _{B(on)} = 15 mAdc, V _{EB(off)} = 0.5 Vdc) Figure 1	t _r	-	25	
Storage Time $(V_{CC} = 30 \text{ Vdc}, I_C = 150 \text{ mAdc},$	t _s	-	225	ns
Fall Time $I_{B(on)} = I_{B(off)} = 15 \text{ mAdc}$ Figure 2	t _f	-	60	

PZT2222AT1

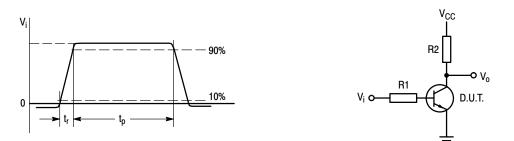


Figure 1. Input Waveform and Test Circuit for Determining Delay Time and Rise Time

PULSE GENERATOR: PULSE DURATION RISE TIME DUTY FACTOR	$t_p 3 200 ns$ $t_r 3 2 ns$ $\delta = 0.02$	OSCILLOSCOPE: INPUT IMPEDANCE INPUT CAPACITANCE RISE TIME	Z _i > 100 kΩ C _i < 12 pF t _r < 5 ns
DUTTFACTOR	0 = 0.02		4 × 5115

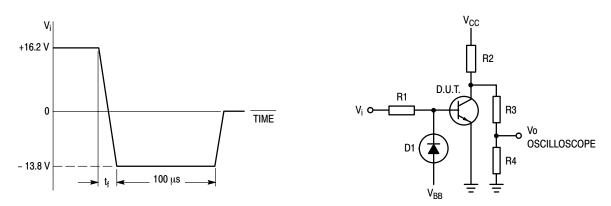
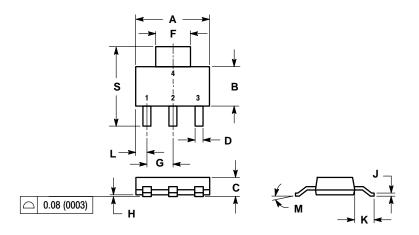


Figure 2. Input Waveform and Test Circuit for Determining Storage Time and Fall Time

PACKAGE DIMENSIONS

SOT-223 (TO-261) CASE 318E-04 ISSUE K



2	Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.								
2.	00		HES	MILLIMETERS					
	DIM	MIN	MAX	MIN	MAX				
	Α	0.249	0.263	6.30	6.70				
	В	0.130	0.145	3.30	3.70				
	С	0.060	0.068	1.50	1.75				
	D	0.024	0.035	0.60	0.89				
	F	0.115	0.126	2.90	3.20				
	G	0.087	0.094	2.20	2.40				
	Η	0.0008	0.0040	0.020	0.100				
	J	0.009	0.014	0.24	0.35				
	К	0.060	0.078	1.50	2.00				
	L	0.033	0.041	0.85	1.05				
	М	0 °	10 °	0 °	10 °				
	S	0.264	0.287	6.70	7.30				

DIMENSIONING AND TOLERANCING PER ANSI

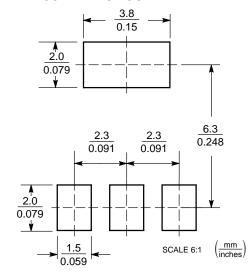
STYLE 1: PIN 1. BASE

NOTES:

1.

2. COLLECTOR 3. EMITTER 4. COLLECTOR

SOLDERING FOOTPRINT*



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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